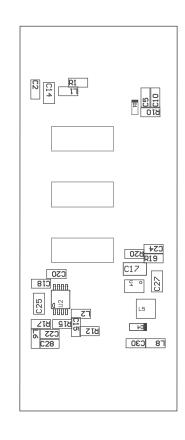


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: Final TIDA-00688

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00688	REV:	SUN REU	: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 08.12.	2015 10:27:44		TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: Final TIDA-00688

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00688	REV:	SUN REV	: Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 08.12.2	2015 10:27:48		TEXAS INSTRUMENTS

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